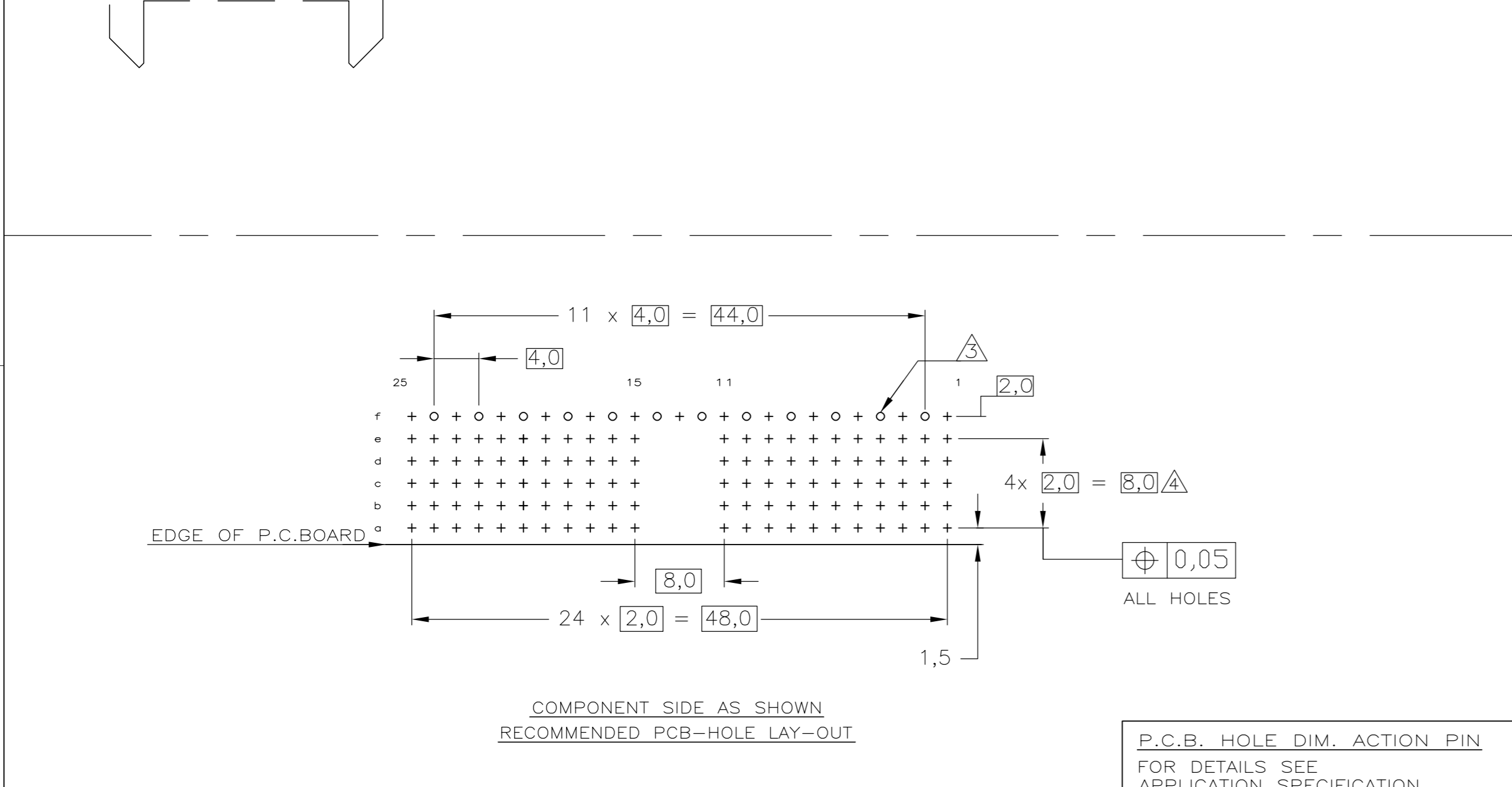
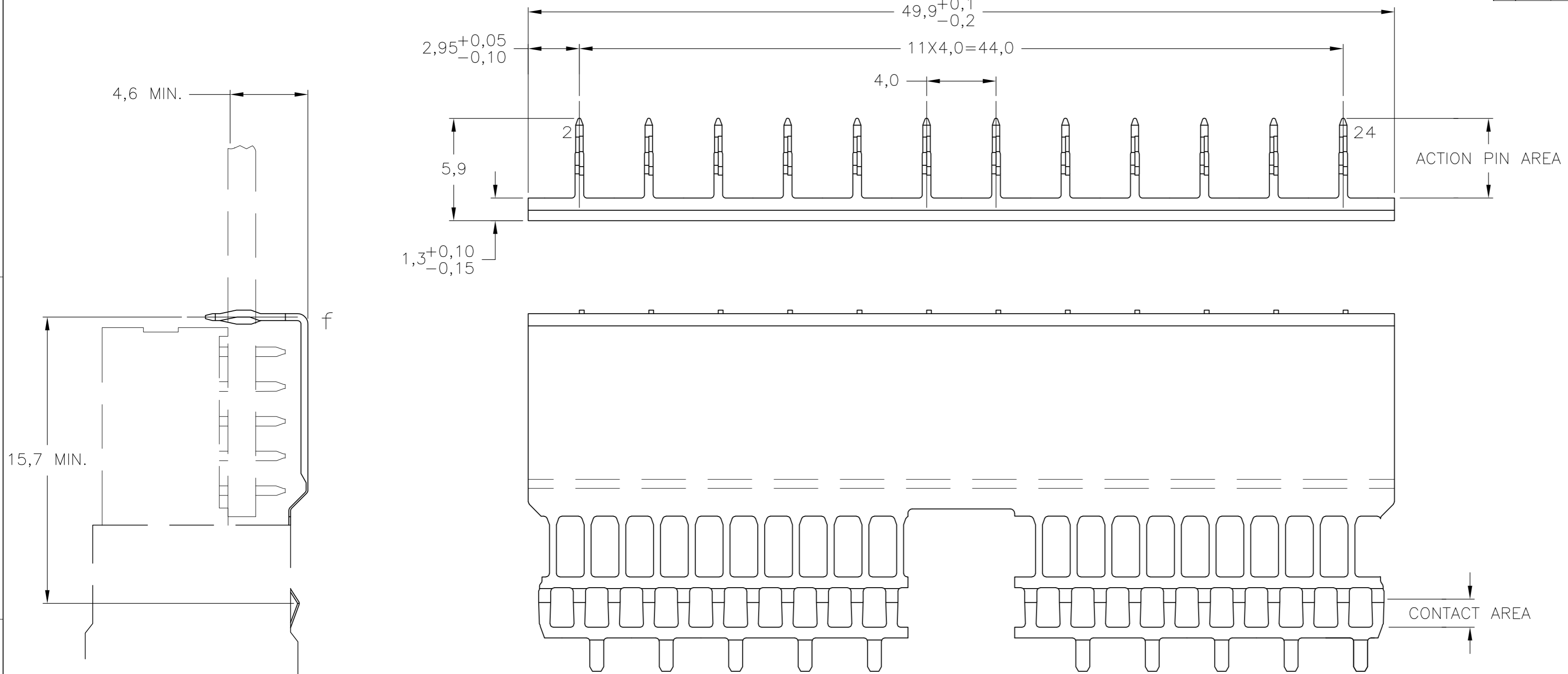


THIS DRAWING IS UNPUBLISHED. RELEASED FOR PUBLICATION
 © COPYRIGHT - By - ALL RIGHTS RESERVED.

LOC		DIST		REVISIONS			
P	LTR	DESCRIPTION		DATE	DWN	APVD	
H	-	D	REVISED PER ECO-13-015151	16DEC2013	FL	FY	



- NOTES:**
- △ GENERAL PLATING SPECIFICATION: UNDERPLATING (ENTIRE CONTACT): 1,27µm NICKEL MIN. AND ACTION PIN: 0,5µm TIN MIN. FOR PLATING OF MATING SURFACES SEE PERFORMANCE LEVEL SHOWN IN PART NUMBER TABLE.
 - △ MATERIAL; PHOSPHORBRONZE.
 - △ ROW "f" 12 PLATED THROUGH HOLES FOR LOWERSHIELD.
 - △ HOLE PATTERN FOR FEMALE CONNECTOR TYPE A WITH UPPERSHIELD, 110+13 PLATED-THROUGH HOLES AT 2x2mm SQUARE GRID.
 - 5 MAX. BOARD THICKNESS 3,5 mm.
 - △ SHIELDS LUBRICATED WITH BELLCORE APPROVED LUBRICANT. TECHNICAL REF: TR-NWT-001217 ISSUE 1, SEPT. 1992.
 - △ CONFORMS TO ALL TESTING ACCORDING IEC 61076-4-101 PERFORMANCE LEVEL 2.
 - △ CONFORMS TO ALL TESTING ACCORDING IEC 61076-4-101 PERFORMANCE LEVEL 1.
 - △ CONNECTOR TESTED AND QUALIFIED AGAINST TELCORDIA GR-1217-CORE QUALITY LEVEL III, CENTRAL OFFICE APPLICATIONS.
 - △ 0.76µm MIN GOLD PLATING AT MATING SURFACE.

FINISH	MATERIAL	PARTNUMBER
△ △ △ △ △	△	4-5338108-0
△ △ △ △ △	△	5338108-9
△ △ △ △ △	△	5338108-2

THIS DRAWING IS A CONTROLLED DOCUMENT.

DIMENSIONS: mm	TOLERANCES UNLESS OTHERWISE SPECIFIED: ±0.2	DWN: K.N.KIRAN 13AUG04	CHK: B.MOOIJ 25MAR05	APVD: B.MOOIJ 25MAR05	NAME: K.N.KIRAN
		PRODUCT SPEC: 108-19082	APPLICATION SPEC: 114-19029	WEIGHT: -	SIZE: A2
MATERIAL: -		CUSTOMER DRAWING		SCALE: 5:1	SHEET: 1 of 1

TE Connectivity

Z-PACK 2mm HM
GROUND RETURN LOWER SHIELD
TYPE A

RESTRICTED TO: -

5338108

单击下面可查看定价，库存，交付和生命周期等信息

[>>TE Connectivity\(泰科\)](#)